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Application Number	09/836,545	HECE	
Filing Date	April 18, 2001	TILOE	AFF
First Named Inventor	Shinpei Okajima		
Group Art Unit	3618	.1111 17	วกกง
Cuantia a a Nama			LUU∥

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0 3800 MAIL R**OO**M **U.S. PATENT DOCUMENTS** U.S. Patent Document Name of Patentee or Applicant of Cited Document Date of Publication of Cited Document Kind Code MM-YYYY Number (if known) 5722680 Dodge 03-1998 3 m 6099018 Maravetz et al. 08-2000 MB 6123354 Laughlin et al. 09-2000 MB 12-2000 6164682 Okajima et al. MB

FOREIGN PATENT DOCUMENTS								
Examiner Initials*	Cite No.	Fo	oreign Patent Doc	ument	Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-YYYY	Translation (Yes or No)	
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Examiner Signature	Melode	m. Buch	Date Considered	4/16/02	

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